

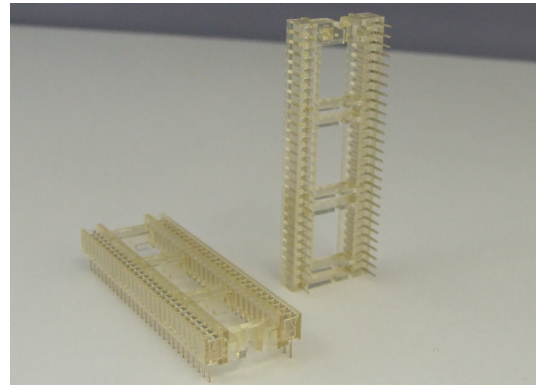
1.778mm Shrink pitch DIP Socket (SDIP)

✓ RoHS

Product Name

IC310 - 56 06 - S 4

①	IC310series
②	Number of contacts
③	Row space of IC-leads
④	Plating of solder terminal S:Sn plating
⑤	Type of solder terminal 4: Straight solder DIP type



Feature

- Transparent resin being visible inside of the socket
- Sn-plating for plating of solder terminal preventing IC-lead contacting different material plating
- Another variation, Black mold type (IC142 series) also available
- IC310B series, 64pin available to attach transparent resin-cover

Packing quantity

48 pcs/tray

Minimum order quantity

More than 48pcs (48pcs/unit)

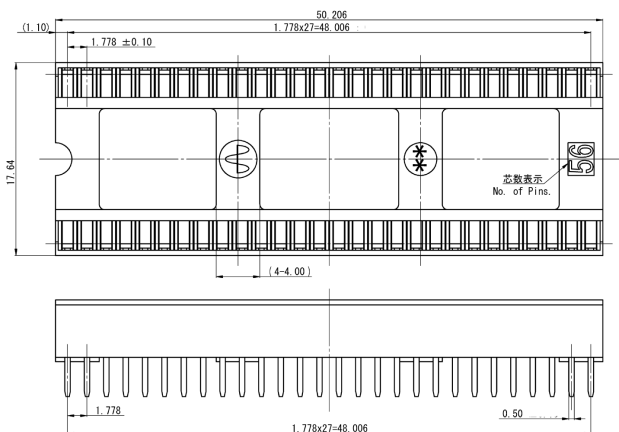
Specification

Rated current	1A
Rated voltage	DC50V
Insulation resistance	>1000MΩ at 500VDC
Withstanding voltage	AC500V. 1min.
Contact resistance	<30Ω
Operating temperature	-40°C ~ +85°C

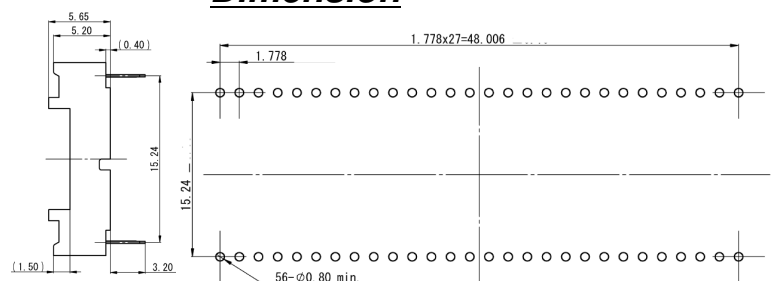
Material & Plating

Parts name	Material & Plating
Insulator	Heat Resisting Plastic
Contact	Material : Copper alloy Plating : Sn Plating

Outline Dimension



Recommended Foot Pattern Dimension



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